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Attorney Docket No. 0756-2447

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Shunpei YAMAZAKI et al.
Serial No. 10/084,935
Filed: March 1, 2002
For: INSULATING FILM AND METHOD
OF PRODUCING SEMICONDUCTOR
DEVICE

Group Art Unit: 2815

Examiner: Jerome Jackson, Jr.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on November 14,

2006.

SPONSE

## <u>RESPONSE</u>

Honorable Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

The Official Action mailed August 14, 2006, has been received and its contents carefully noted. This response is filed within three months of the mailing date of the Official Action and therefore is believed to be timely without extension of time. Accordingly, the Applicant respectfully submits that this response is being timely filed.

Initially, it is noted that the Applicant would like to discuss the present application with the Examiner. The Applicant will contact the Examiner to arrange a mutually agreeable time and place for the interview.

The Applicant notes with appreciation the consideration of the Information Disclosure Statements filed on March 1, 2002; June 4, 2002; October 3, 2002; April 11, 2003; December 16, 2003; and March 27, 2006.

Claims 19-26 and 35-62 are pending in the present application, of which claims 19, 35, 43 and 51 are independent. For the reasons set forth in detail below, all claims are believed to be in condition for allowance. Favorable reconsideration is requested.

The Official Action rejects claims 19-26 and 35-62 under 35 U.S.C. § 112, first paragraph, asserting that "there is no support for an 'interlayer insulating film' having the